2SK2922

Silicon N Channel MOS FET UHF Power Amplifier

HITACHI

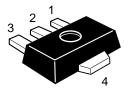
ADE-208-675(Z) 1st. Edition Aug. 1998

Features

- High power output, High gain, High efficiency
 PG = 8.0dB, Pout = 31dBm, ηD = 57 % min. (f = 836.5MHz)
- Compact package capable of surface mounting

Outline

UPAK



- 1. Gate
- 2. Source
- 3. Drain
- 4. Source

This Device is sensitive to Electro Static Discharge.

An Adequate handling procedure is requested.



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Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit	
Drain to source voltage	$V_{\scriptscriptstyle DSS}$	10	V	
Gate to source voltage	V_{GSS}	±6	V	
Drain current	I _D	0.7	Α	
Drain peak current	I Note1 D(pulse)	1.4	Α	
Channel dissipation	Pch Note2	3	W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-45 to +150	°C	

Note: 1. PW ≤ 10ms, duty cycle ≤ 50 %

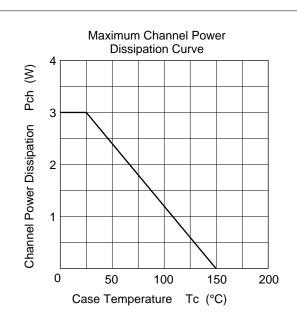
2. Value at Tc = 25°C

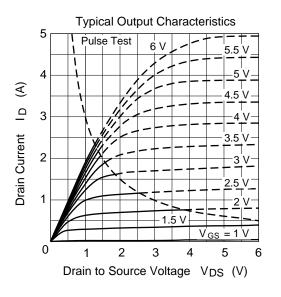
Electrical Characteristics ($Ta = 25^{\circ}C$)

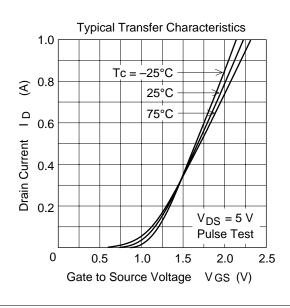
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Zero gate voltage drain current	I _{DSS}	_	_	100	μΑ	$V_{DS} = 10 \text{ V}, V_{GS} = 0$
Gate to source leak current	I _{GSS}	_	_	±5.0	μΑ	$V_{GS} = \pm 6V$, $V_{DS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	0.4	_	1.2	V	$I_D = 3mA$, $V_{DS} = 5V$
Input capacitance	Ciss	_	27	_	pF	$V_{GS} = 2V, V_{DS} = 0, f = 1MHz$
Output capacitance	Coss	_	13	_	pF	$V_{DS} = 5$, $V_{GS} = 0$, $f = 1MHz$
Output Power	Pout	31			dBm	$V_{DS} = 4.7V, f = 836.5Mhz$ Pin = 23dBm
Drain Rational	ηD	57	_	_	%	V _{DS} = 4.7V, f =836.5Mhz Pin = 23dBm

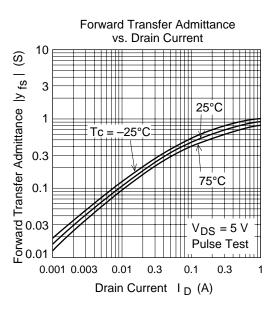
Note: 1. Marking is "HX".

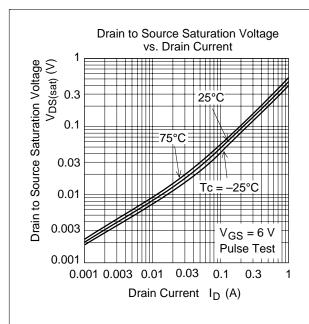
Main Characteristics

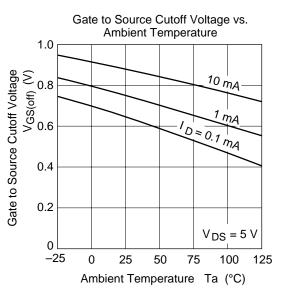


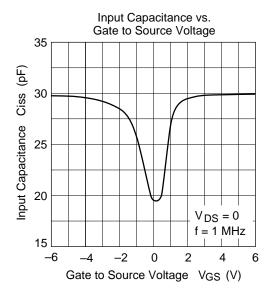


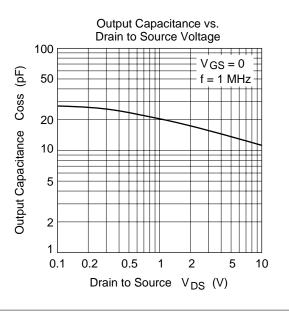


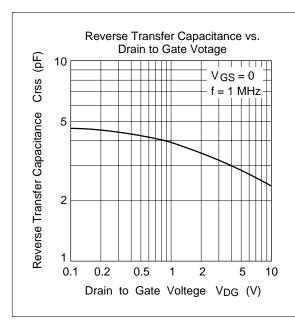


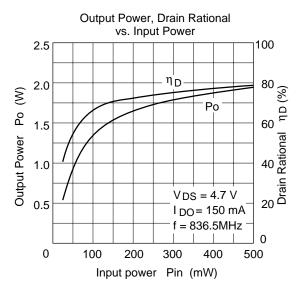






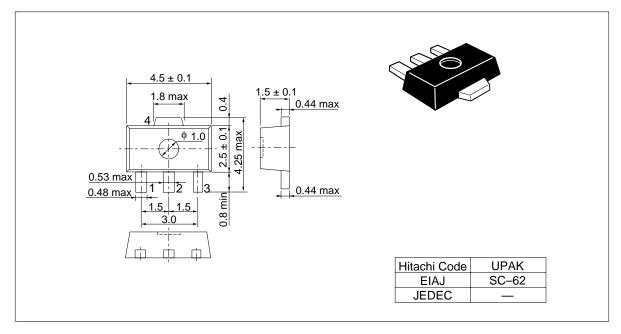






Package Dimensions

Unit: mm



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